

Section

MV Semi-conductor

ApplicationField
Laboratory
Production**PRODUCT BENEFITS**Fine tuning of the scoring depth
Chamfer on the transition**TOOL CAPACITY**

Diameter	14 - 50 mm 0,551 - 1,969 inch
Max scoring depth	1,4mm / 0,055 in
Remaining length of semicon	10 mm / 0,394 in

TOOL DIMENSIONS

Length	150 mm
Width	80 mm
Height	48 mm
Weight without box	0,695 Kg
Packaging	Box

Tool to remove peelable semiconductor and stop for MV cable

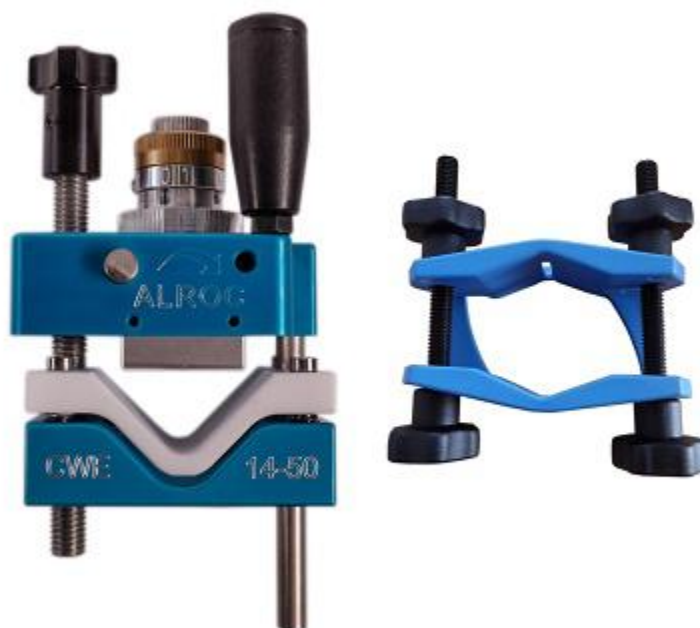
TO DO WHAT

The CWE/14-50-MVS enables the user to score the peelable semiconductor, in order to remove it.

It performs a chamfer on the semicon cutback.

Its design enables to make circular, longitudinal and helicoidal cuts.

The MVS sits on the cable to stop the CWE/14-50 with a large contact surface.

**Spare part**

MVS - Stop for tools

LS-CD6 - Spare blade for semiconductor scoring with chamfer

Associated tool

CWB/18-60-MVS - Remove bonded semiconductor with chamfer on the semiconductor cutback and stop

BRMRD1E - Tool to remove insulation

MV cables Tools

CWE/14-50-MVS



Part Number	Diameter	Tool capacity		Dimensions			Packaging
		Max scoring depth	Remaining length of semicon	Length	Width	Height	
CWE/14-50-MVS	14 - 50 mm 0,551 - 1,969 in	1,4mm / 0,055 in	10 mm / 0,394 in	150 mm 5,906 in	80 mm 3,150 in	48 mm 1,890 in	box



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